



US00D729194S

(12) **United States Design Patent**
Boeckel et al.

(10) **Patent No.:** **US D729,194 S**

(45) **Date of Patent:** **** May 12, 2015**

(54) **HEADPHONE**

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(**) Term: **14 Years**

(21) Appl. No.: **29/481,912**

(22) Filed: **Feb. 12, 2014**

(30) **Foreign Application Priority Data**

Aug. 13, 2013 (EM) 002291070-0002

(51) **LOC (10) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
CPC H04R 1/1066
USPC D14/205; D29/112; 2/209; 181/129,
181/130, 135; 379/430, 431; 381/380, 381,
381/374, 379; 455/90.3, 575.1
See application file for complete search history.

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(Continued)

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(57) **CLAIM**

The ornamental design for headphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a headphone according to an embodiment of the claimed design;
FIG. 2 is a front elevational view of the headphone of FIG. 1;
FIG. 3 is a rear elevational view of the headphone of FIG. 1;
FIG. 4 is a left elevational view of the headphone of FIG. 1;
FIG. 5 is a right elevational view of the headphone of FIG. 1;
FIG. 6 is a top elevational view of the headphone of FIG. 1;
and,
FIG. 7 is a bottom elevational view of the headphone of FIG. 1.
The features shown in broken lines are environment only and not part of the claimed design.

1 Claim, 5 Drawing Sheets



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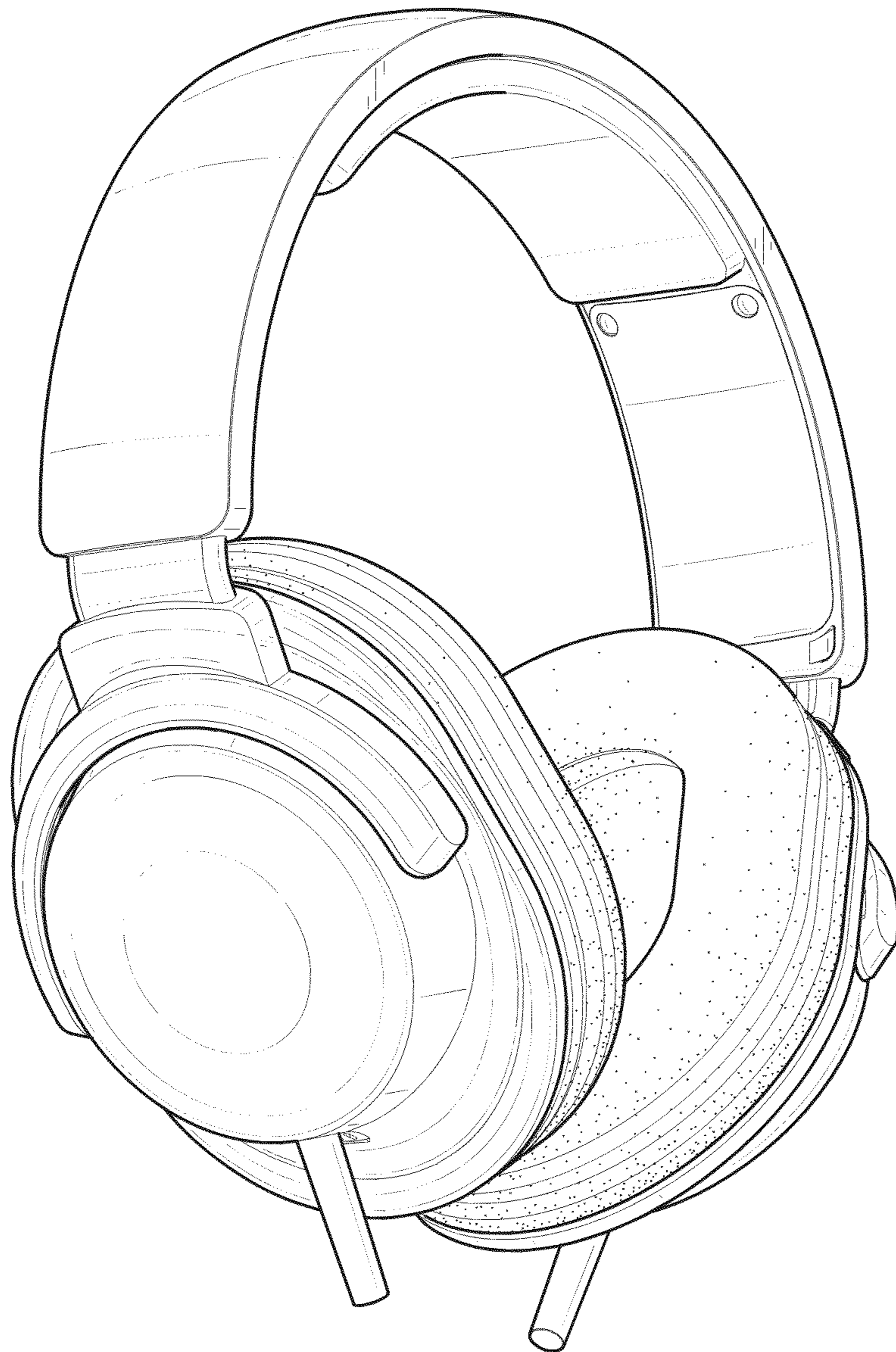


FIG. 1



FIG. 2



FIG. 3

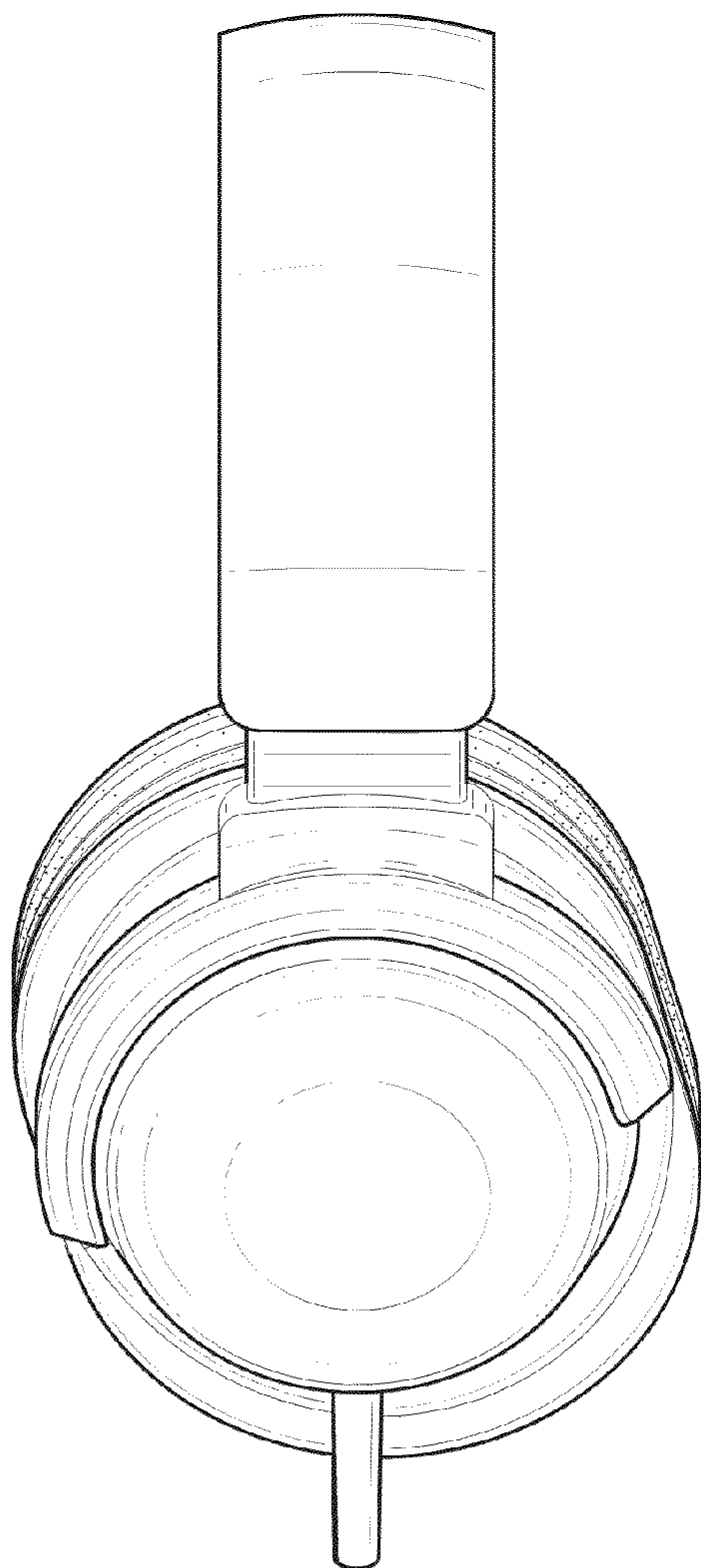


FIG. 4

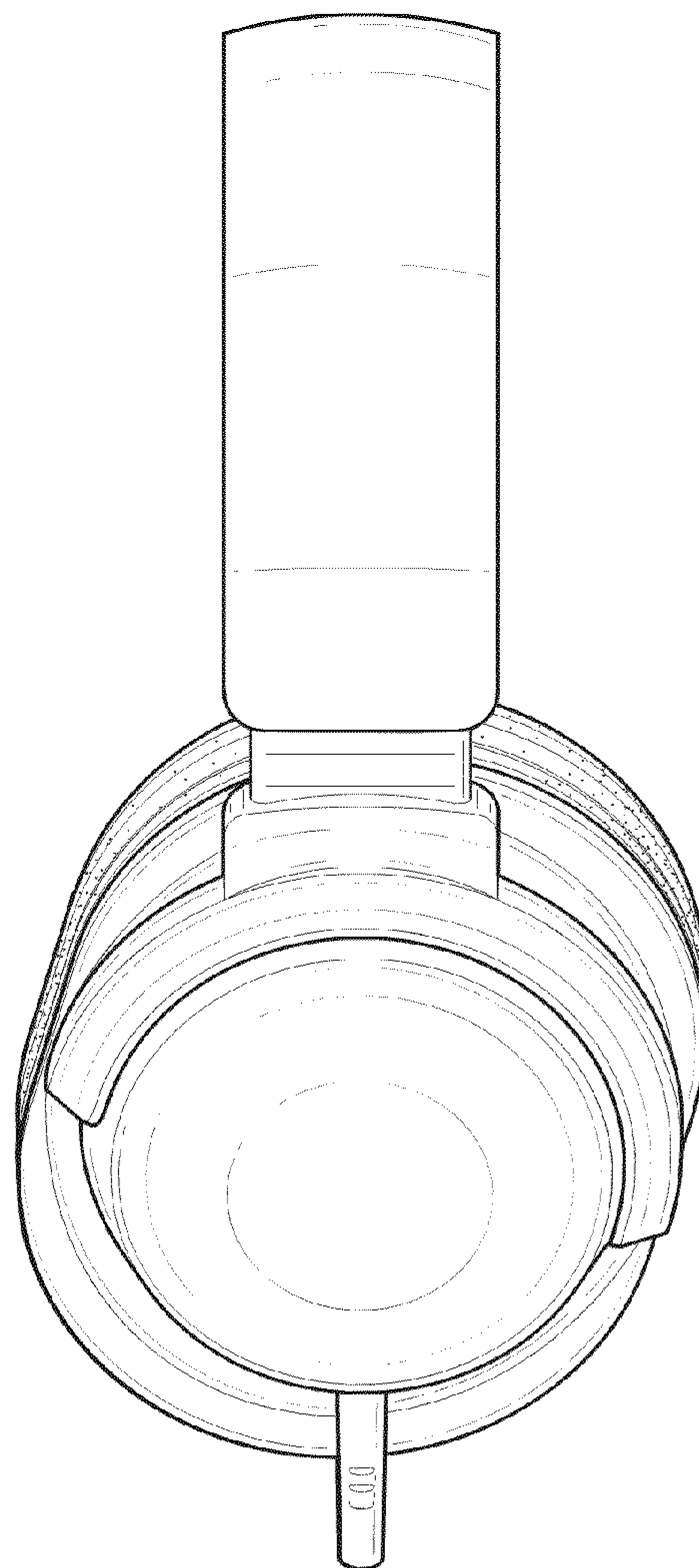


FIG. 5

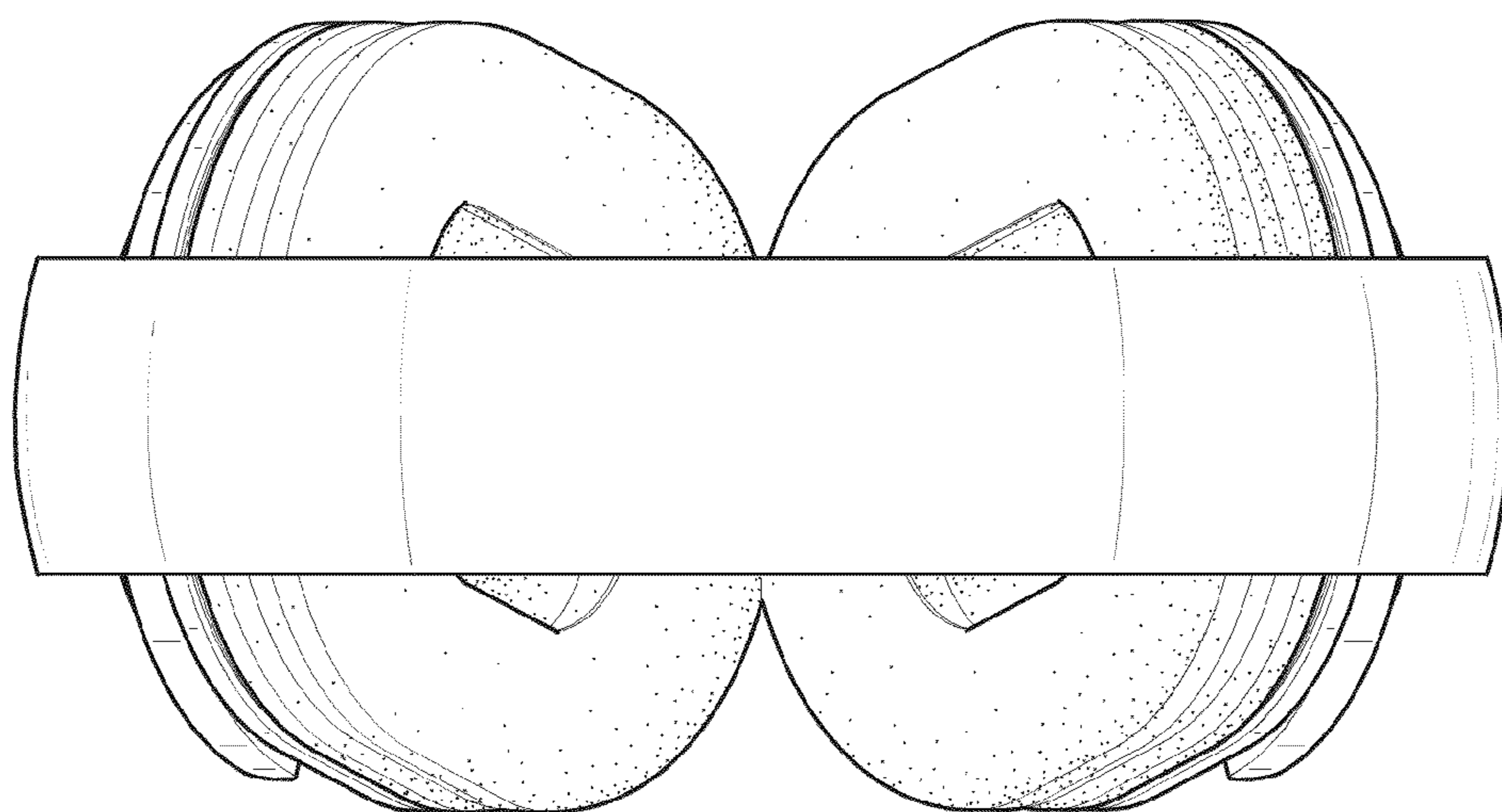


FIG. 6

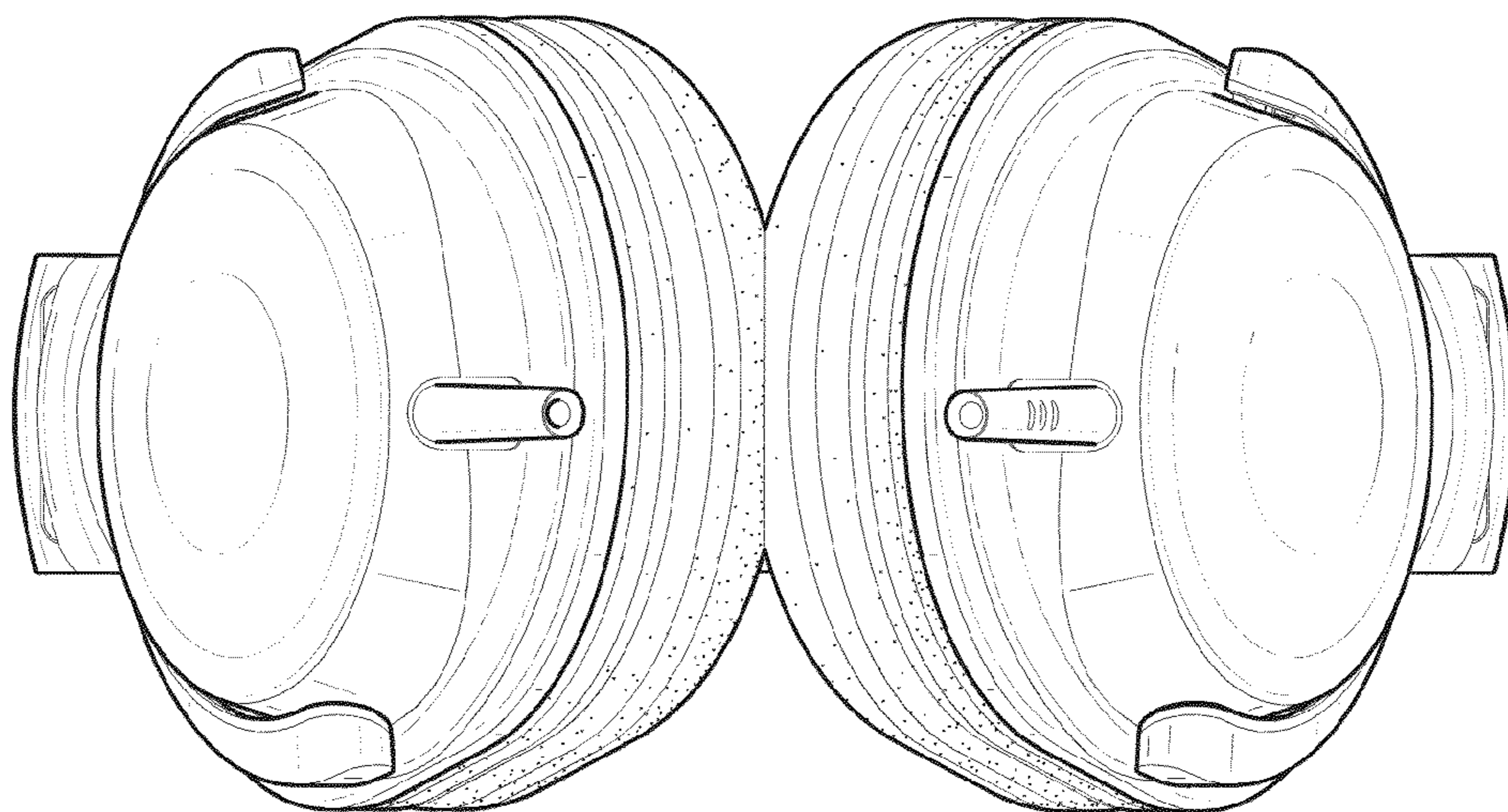


FIG. 7